Electronic Pat	ciic App	incution i ee		ittui			
Application Number:	10	10521723					
Filing Date:	10-	10-Apr-2006					
Title of Invention:	IAF	IAP BINDING COMPOUNDS					
First Named Inventor/Applicant Name:	Yig	Yigong Shi					
Filer:	Ray	Raymond A. Miller/Emily Scattaregia					
Attorney Docket Number:	11:	112911.01901					
Filed as Small Entity							
U.S. National Stage under 35 USC 371 F	iling Fee	5					
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:					I		
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-interference:							
Post-Allowance-and-Post-Issuance:							
Utility Appl issue fee		2501	1	755	755		

Publ. Fee- early, voluntary, or normal

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			1055